

BGA Rework Station with Laser Positioning

This BGA rework station is suitable for repairing laptop, desktop, and smartphone motherboards. It features three independently controlled temperature zones and a user-friendly interface for easy operation.



Overview

Professional BGA Rework Station

This advanced BGA rework station is engineered for high-precision motherboard repair, making it an essential tool for servicing laptops, desktops, and smartphones. Featuring three independently controlled temperature zones, it ensures optimal thermal management for complex chip repairs. With integrated laser positioning, the system provides the accuracy required for professional electronics manufacturing and repair environments.

Technical Specifications

Supported Devices

- Laptop Motherboards
- Desktop Motherboards
- Smartphone Motherboards

Heating Zones

3 zones

Positioning

Laser Positioning

Compatible Components

Laptop CPU, VGA, South Bridge, North Bridge, STP CPU

Features

Key Features

Laser Positioning • Independent Heating • User-Friendly Interface